

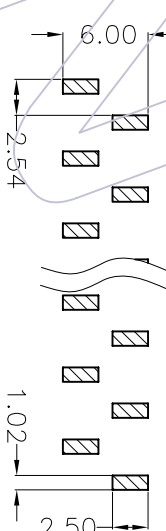
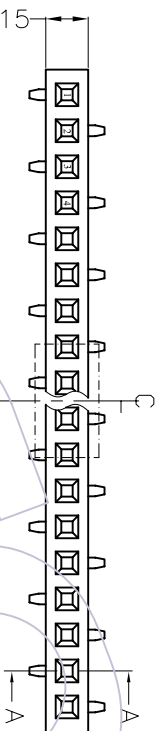
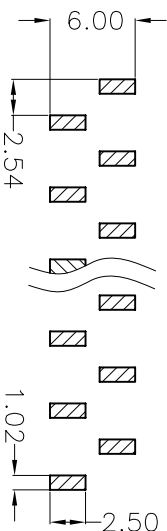
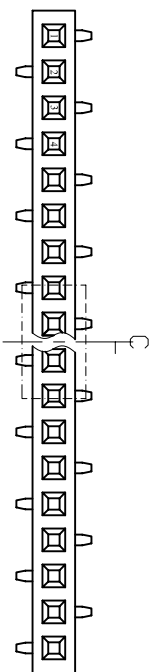
HSP

NOTES:

Current Rating: 3.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C

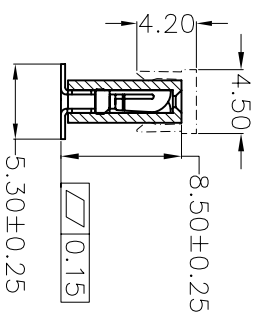
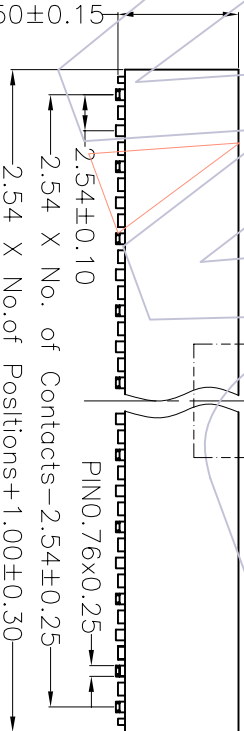
Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G. F UL94V-0

Recommended P.C.B Layout(TOP Side)
 (PCB BOARD TOLERANCE±0.05)



Type 1

Type 2



Ordering Information

2185 - 1 XX M XX C U N T X

No. of Pins per ROW: 02-40PIN
 Contact Plating: GO=Gold Flash, GI=3μ"Gold, GS=5μ"Gold, G3=10μ"Gold, G4=15μ"Gold, GS=30μ"Gold
 SO=Gold Flash/Tin, SI=3μ"Gold/Tin, S2=5μ"Gold/Tin, S3=10μ"Gold/Tin, S4=15μ"Gold/Tin, S5=30μ"Gold/Tin, SN=1Tin
 Packing: T=tube, I=TYPE 1, 2=TYPE 2
 R=Tube&Reel+CAP

TYPE	PART NO.
TYPE 1	2185-1XXMXXCUNT1
TYPE 2	2185-1XXMXXCUNT2

WCON 维峰五金电子有限公司
 WAVE HARDWARE ELECTRONICS CO.,LTD

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	08/03/12	NEW			XXX ±0.40 XXX ±0.25 XXX ±0.15 Angle ±.3°	DESIGN CHECK		UNIT mm SIZE A4		SHEET 1/1
						APPROVE		PROJ.	Customer NO.	

SSEE TABLE
 FH2.54 SINGLE SMT H=8.50